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Partie 26-3: Protocole de contrôle de dispositif de téléphonie — Niveau 2 — Dispositif de serveur de téléphonie

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ISO/IEC 29341-26-3 was prepared by UPnP Forum and adopted, under the PAS procedure, by joint technical committee ISO/IEC JTC 1, *Information technology*, in parallel with its approval by national bodies of ISO and IEC.

The list of all currently available parts of ISO/IEC 29341 series, under the general title *Information technology — UPnP Device Architecture*, can be found on the ISO web site.

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